

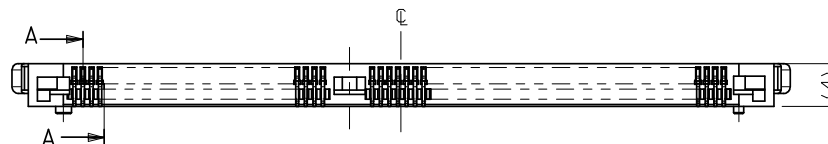
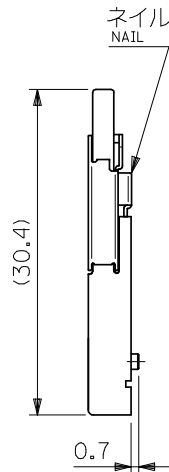
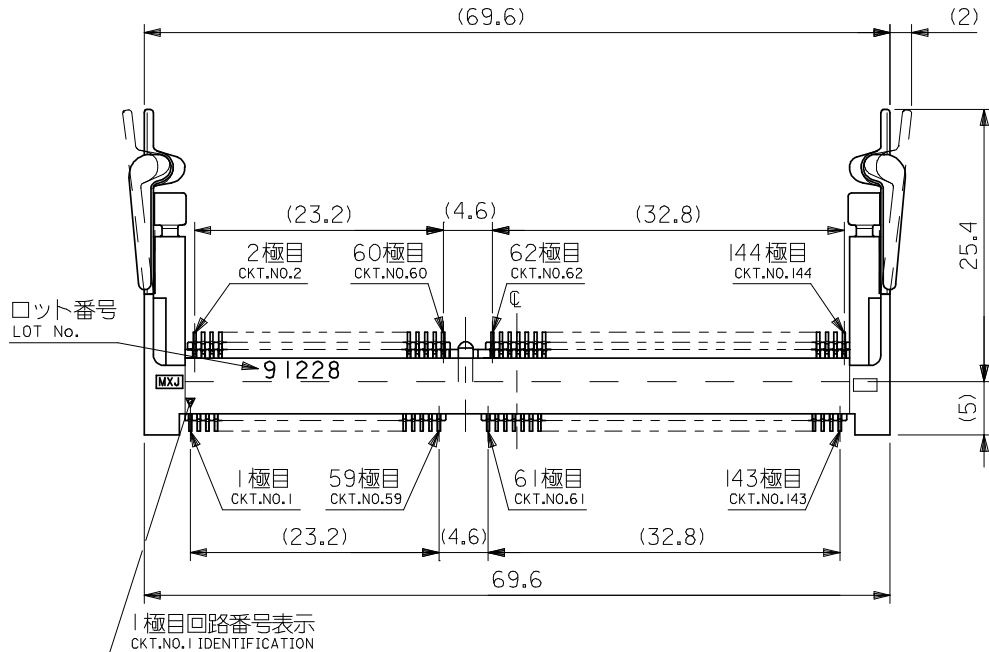
詳細 D
DETAIL D
(SCALE:5-1)

注記 1. 材料 ハウジング : ガラス入り耐熱樹脂、白色、UL94V-0
MATERIAL HOUSING : G.F.HEAT RESISTANT PLASTIC,WHITE,UL94V-0
ターミナル : 磷青銅
TERMINAL : PHOSPHOR BRONZE
ネイル : 黄銅
NAIL : BRASS

2. めっき仕様 ロングターミナル
PLATING LONG TERMINAL
接点部 : 金めっき 0.25μmMIN.
CONTACT AREA : GOLD 0.25 μmMIN.
半田付け部 : 半田めっき 1.0μmMIN.
SOLDER TAIL AREA : TIN-LEAD 1.0μmMIN.
下地めっき : ニッケルめっき 2.0μmMIN.
UNDER-PLATING : NICKEL 2.0μmMIN.
ショートターミナル
SHORT TERMINAL
接点部 : 金めっき 0.25μmMIN.
CONTACT AREA : GOLD 0.25 μmMIN.
半田付け部 : 金めっき 0.3μmMAX.
SOLDER TAIL AREA : GOLD 0.3μmMAX.
下地めっき : ニッケルめっき 2.0μmMIN.
UNDER-PLATING : NICKEL 2.0μmMIN.

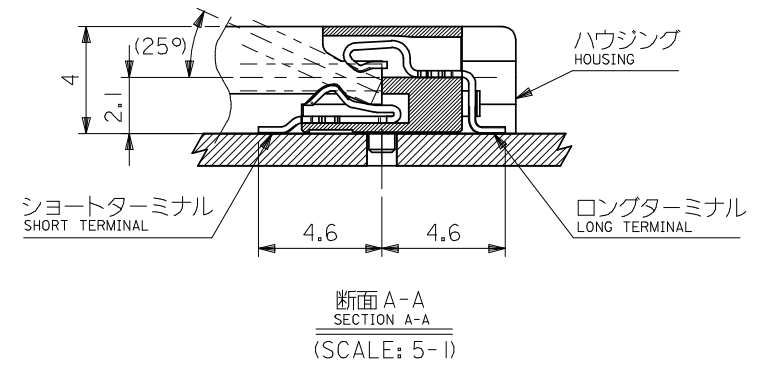
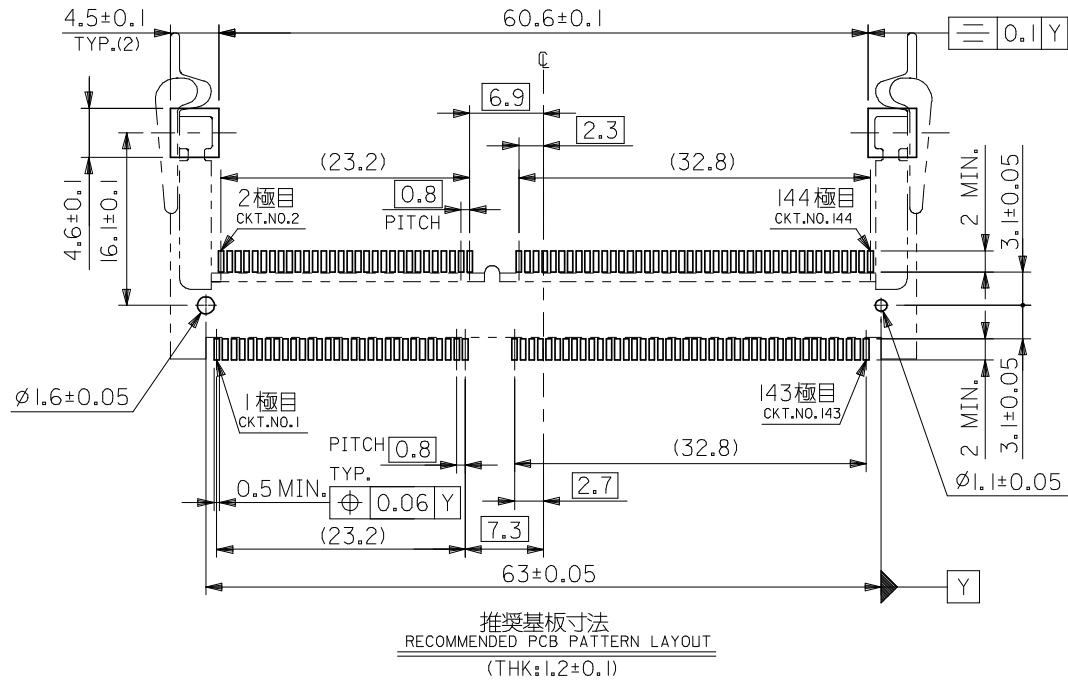
ネイル
NAIL
半田めっき : 2.0μmMIN.
TIN-LEAD : 2.0μmMIN.

3. テール平坦度は、0.1 MAX.とする。
TAIL COPLANARITY TO BE 0.1 MAX.
ネイル平坦度は、0.1 MAX.とする。
NAIL COPLANARITY TO BE 0.1 MAX.

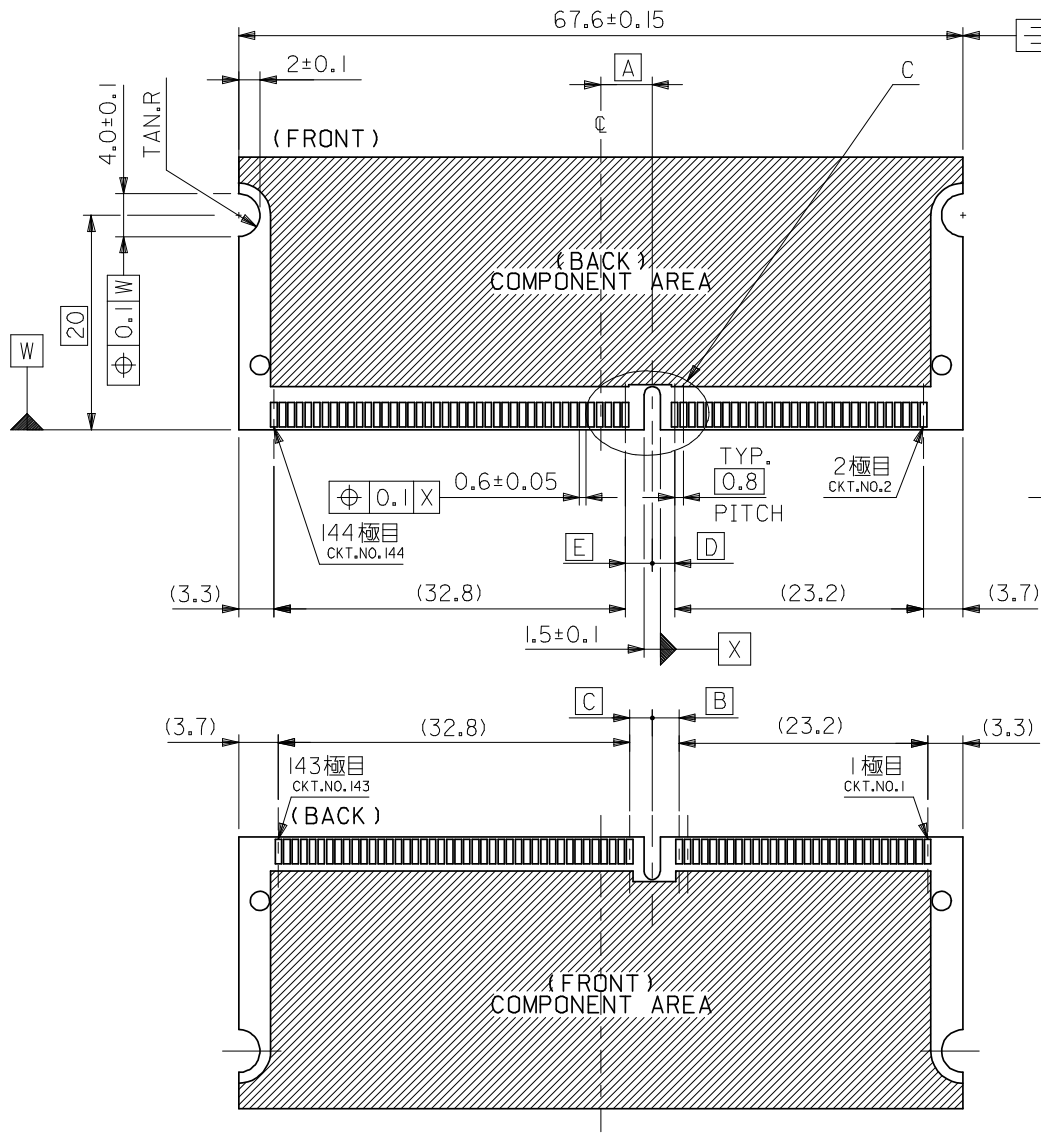


2.5	2.1	2.1	2.5	4.8	3.3V	標準トレイ NORMAL TRAY	54697-1440	54697-144*
E	D	C	B	A	POWER SUPPLY	梱包トレイ PACKAGING TRAY	MATERIAL NO.	MODEL NO.

REVISED EC NO: J2008-1539 DRW:KI INOSHITAA 2008/04/09 CHK:O.T. HARUYAMA 2008/04/09 APPR:NUKITA 2008/06/09	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 2:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	
	10 UNDER	±0.2	DRAWN BY T. KANEKO		DATE '99/9/27		TITLE 0.8MM PITCH S.O.DIMM SOCKET 144CKT. HEIGHT 4MM	
	10 OVER 30 UNDER	±0.25	CHECKED BY J. MIYAZAWA		DATE '99/9/27			
	30 OVER	±0.3	APPROVED BY H. IKESUGI		DATE '99/9/27		MOLEX INCORPORATED	
	ANGULAR ±3 °		MATERIAL NO.		DOCUMENT NO.			
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE TABLE		SD-54697-001				
THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION								



REVISED EC NO: J2008-1539 DRW:K INOSHITA 2008/04/09 CHK:D T. HARUYAMA 2008/04/09 APPR: NUKITA 2008/06/09	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 2:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	
	10 UNDER	±0.2	DRAWN BY T. KANEKO	DATE '99/9/27	TITLE 0.8MM PITCH S.O.DIMM SOCKET 144CKT. HEIGHT 4MM			
	10 OVER 30 UNDER	±0.25	CHECKED BY J. MIYAZAWA	DATE '99/9/27				
	30 OVER	±0.3	APPROVED BY H. IKESUGI	DATE '99/9/27	MOLEX INCORPORATED			
	ANGULAR ±3 °		MATERIAL NO.	DOCUMENT NO.				
	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE SHEET 1		SD-54697-001			
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推奨基板寸法
RECOMMENDED MATING BOARD CONFIGURATION
(THK:1.0±0.1)

REVISED EC NO: J2008-1539 DRAWN: K INOSHITA 2008/04/09 CHKD: T HARUYAMA 2008/04/09 APPR: NUKITA 2008/06/09	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY	SCALE 2:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION
	10 UNDER	±0.2	DRAWN BY T. KANEKO	DATE '99/9/27	TITLE 0.8MM PITCH S.O.DIMM SOCKET 144CKT. HEIGHT 4MM MOLEX INCORPORATED DOCUMENT NO. SD-54697-001 SHEET NO. 3 OF 3	
	10 OVER 30 UNDER	±0.25	CHECKED BY J. MIYAZAWA	DATE '99/9/27		
	30 OVER	±0.3	APPROVED BY H. IKESUGI	DATE '99/9/27		
	ANGULAR	±3 °	MATERIAL NO.	SEE SHEET 1		
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			